

General Description

The WSD3030DN is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD3030DN meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

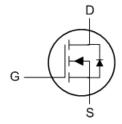
BVDSS	RDSON	ID
30V	10mΩ	34A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

DFN3X3-8 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage 30		V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	34	Α	
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	21	Α	
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	12	Α	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	10	А	
I _{DM}	Pulsed Drain Current ²	80	Α	
EAS	Single Pulse Avalanche Energy ³	25	mJ	
I _{AS}	Avalanche Current	23	Α	
P _D @T _C =25℃	Total Power Dissipation ⁴	25	W	
P _D @T _A =25℃	Total Power Dissipation ⁴	2.5	W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
T_J	Operating Junction Temperature Range -55 to 150		$^{\circ}$ C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹		70	°C/W	
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		5	°C/W	



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃, I _D =1mA		0.0232		V/°C
В	Static Drain-Source On-Resistance ²	V_{GS} =10V , I_D =20A		10	12	0
R _{DS(ON)}		V _{GS} =4.5V , I _D =10A		13	16	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	\\ _\\ 250\	1.3	1.9	2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-5.08		mV/℃
	Drain Source Lookage Current	V_{DS} =24V , V_{GS} =0V , T_J =25 $^{\circ}\mathrm{C}$			1	uA
I _{DSS}	Drain-Source Leakage Current	V_{DS} =24V , V_{GS} =0V , T_J =55 $^{\circ}\mathrm{C}$			5	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA
gfs	Forward Transconductance	V_{DS} =5V , I_D =30A		34		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5	3.3	Ω
Q_g	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =20A		6.1	8	
Q_gs	Gate-Source Charge			2.4	2.9	nC
Q_gd	Gate-Drain Charge			2.3	3.2	
$T_{d(on)}$	Turn-On Delay Time	V_{DD} =15V , V_{GEN} =10V , R_{G} =6 Ω I_{D} =1A , R_{L} =15 Ω		8	14	
T _r	Rise Time			10	17	no
T _{d(off)}	Turn-Off Delay Time			23	62	ns
T _f	Fall Time			5	12	
Ciss	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		760		
C _{oss}	Output Capacitance			130		pF
C _{rss}	Reverse Transfer Capacitance			70		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.1mH , I _{AS} =23A	23			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,6}	V =V =0V Force Current			1	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			80	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1	V
t _{rr}	Reverse Recovery Time			18.5		nS
Qrr	Reverse Recovery Charge	IF=20A,dI/dt=100A/µs,T _J =25℃		10		nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH,I_{AS}=23A
- 4.The power dissipation is limited by 150 °C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

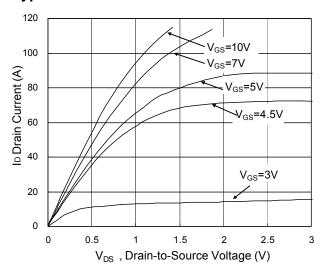


Fig.1 Typical Output Characteristics

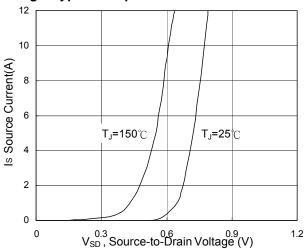


Fig.3 Forward Characteristics of Reverse

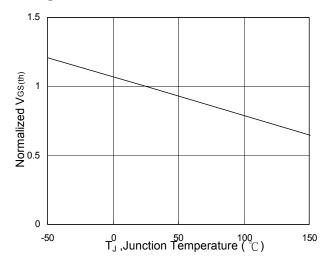


Fig.5 Normalized $V_{\text{GS(th)}}$ vs. T_{J}

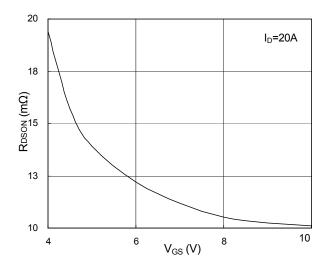


Fig.2 On-Resistance vs. G-S Voltage

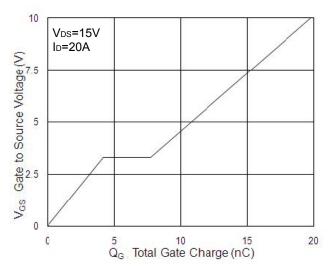


Fig.4 Gate-charge Characteristics

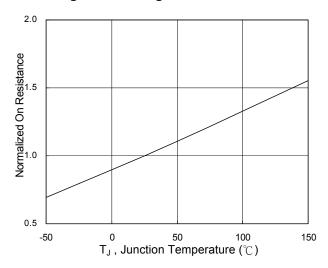
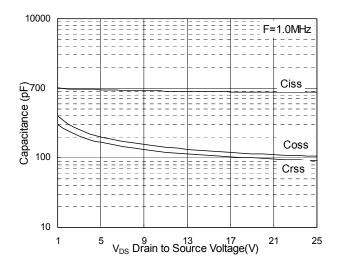


Fig.6 Normalized R_{DSON} vs. T_J





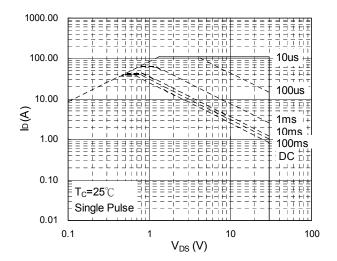


Fig.7 Capacitance

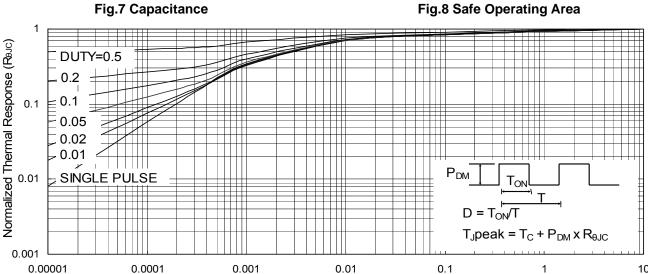
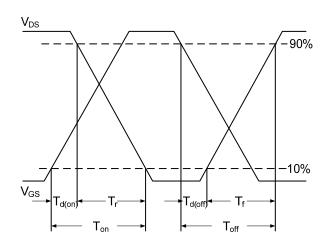
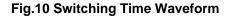


Fig.9 Normalized Maximum Transient Thermal Impedance

t, Pulse Width (s)





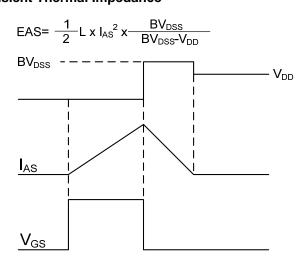


Fig.11 Unclamped Inductive Switching Waveform



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